CRMKTH0709A

N-Channel 68V, 7.3mΩ Typ. Power MOSFET

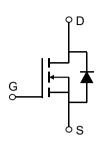
Description

Features

• 68V, 80A

 $R_{DS(ON)}$ Typ = 7.3m Ω @ V_{GS} = 10V

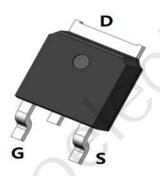
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

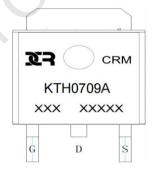




Application

- Load Switch
- PWM Application
- Power Management





Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKTH0709A	CRMKTH0709A	TO-252-3L	TAPING	13"	2500	25000

Absolute Maximum Ratings (@ $T_J = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		68	V
V_{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	80	А
I _D		T _C = 100°C	52	А
I _{DM}	Pulsed Drain Current (1)		320	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		156	mJ
P_{D}	Power Dissipation	T _C = 25°C	116	W
$R_{ hetaJC}$	Thermal Resistance, Junction to Case		1.08	°C/W
T_J, T_STG	Junction & Storage Temperature Range		-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
_	acteristics			J 1-		
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	68	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 68V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	2.8	4	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 10V, I_D = 30A$	-	7.3	9.5	mΩ
	Characteristics					
C _{iss}	Input Capacitance		- /	3960	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 25V,$		260	-	pF
C_{rss}	Reverse Transfer Capacitance	f = 1MHz	X-\	225	-	pF
Q_g	Total Gate Charge		- 1	35	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 30V, I_{D} = 20A$) .	11	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} - 30V, I _D - 20A	-	9	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	15	-	ns
t_r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 30V$	-	94	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 20A, R_{GEN} = 6Ω	-	46	-	ns
\mathbf{t}_{f}	Turn-Off Fall Time		-	32	-	ns
Orain-So	urce Diode Characteristics and M	Max Ratings				
I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	80	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	320	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 - 20 A - 4:1-4 - 4.00 A /	-	30	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 30A$, di/dt = 100A/us	-	50	-	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =30V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =25A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

Typical Performance Characteristics

Figure 1: Output Characteristics 60 50 V_{GS} = 10V 40 (A) 30 $V_{GS} = 4.5V$ 20 $V_{GS} = 4.3V$ 10 V_{GS} = 4.1V $V_{GS} = 3.8V$ 0 0 2 3 VDs(V)

Figure 3: On-resistance vs. Drain Current

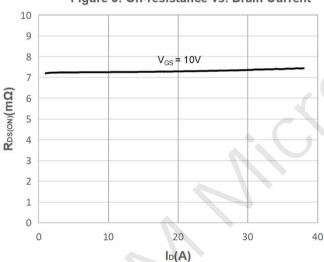


Figure 5: Gate Charge Characteristics

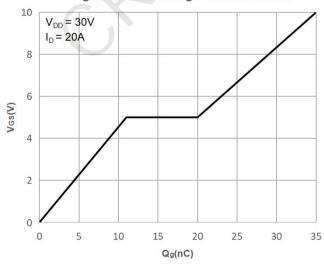


Figure 2: Typical Transfer Characteristics

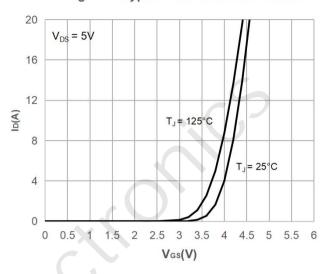


Figure 4: Body Diode Characteristics

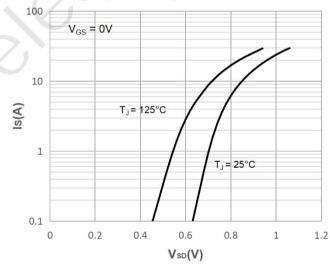
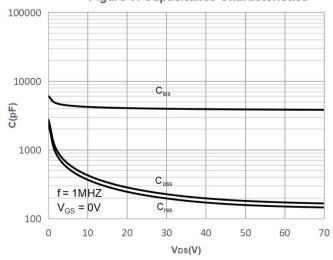


Figure 6: Capacitance Characteristics

Version: 1.1



Typical Performance Characteristics

Figure 7: Normalized Breakdown voltage vs.
Junction Temperature

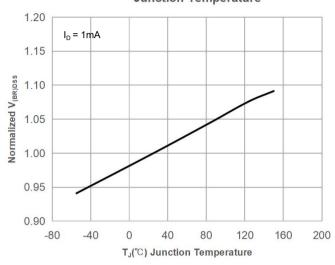


Figure 9: Maximum Safe Operating Area

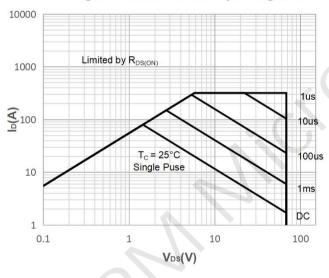


Figure 11: Normalized Maximum Transient

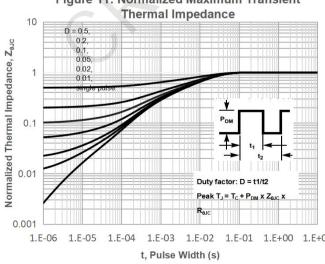


Figure 8: Normalized on Resistance vs. Junction Temperature

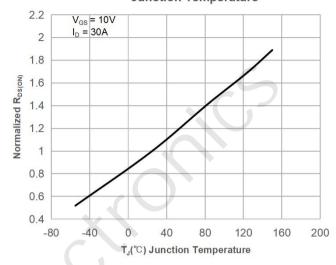


Figure 10: Maximum Continuous Drian Current vs. Case Temperature

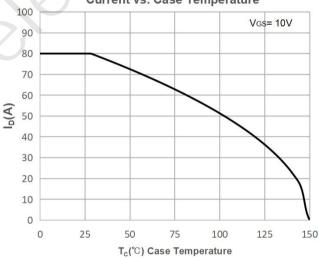
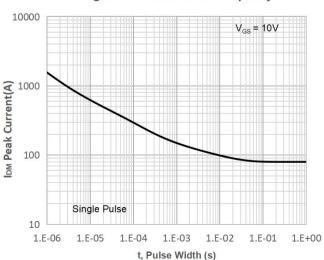


Figure 12: Peak Current Capacity



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Test Circuit

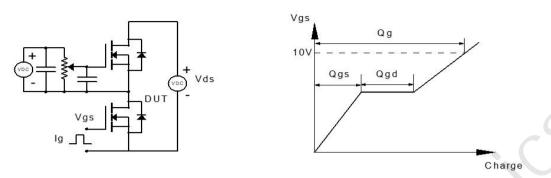


Figure 1: Gate Charge Test Circuit & Waveform

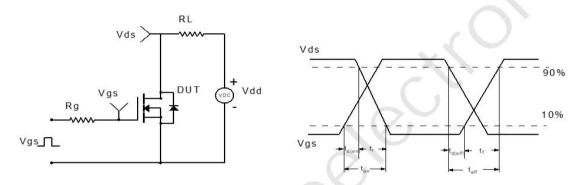


Figure 2: Resistive Switching Test Circuit & Waveform

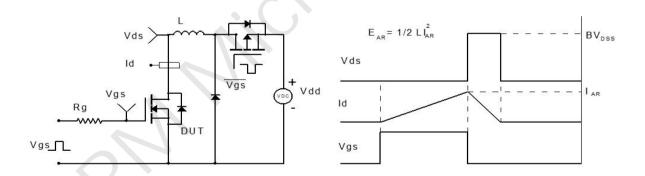


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

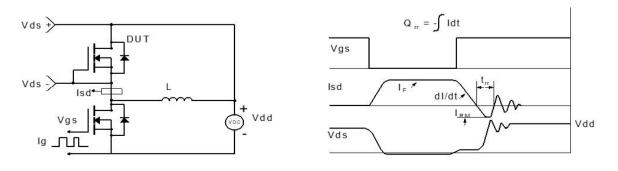
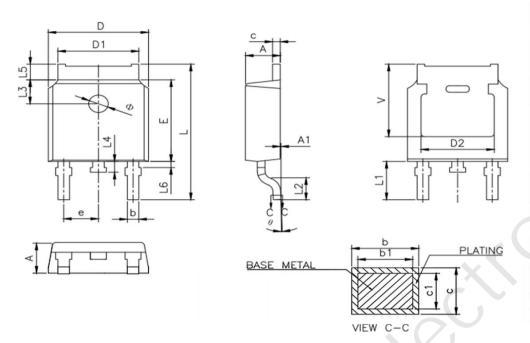


Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(TO-252-3L)



SYMBOL	MILLIMETER				
STWIDOL	MIN	NOM	MAX		
Α	2.20	2.30	2.40		
A1	0.00		0.127		
b	0.66		0.86		
b1	0.65	0.76	0.81		
D	6.50	6.60	6.70		
D1	5.10	5.33	5.46		
С	0.47		0.60		
c1	0.46	0.51	0.56		
D2	4.83 REF.				
E	6.00	6.10	6.20		
е	2.186	2.286	2.386		
L	9.80	10.10	10.40		
L1	2.90 REF.				
L2	1.40	1.50	1.60		
L3	1.80 REF.				
L4	0.60	0.80	1.00		
L5	0.90		1.25		
L6	0.15		0.75		
Ф	1.10		1.30		
θ	0.		8.		
V	5.40 REF				

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